

# Standalone 750mA Li-Ion Battery Charger in 2 × 2 DFN with NTC Thermistor Input

# DESCRIPTION

The LTC®4069 is a complete constant-current/constant-voltage linear charger for single-cell lithium-ion batteries. The 2mm × 2mm DFN package and low external component count make the LTC4069 especially well-suited for portable applications. Furthermore, LTC4069 is specifically designed to work within USB power specifications.

The CHRG pin indicates when charge current has dropped to ten percent of its programmed value (C/10). An internal timer terminates charging according to battery manufacturer specifications.

No external sense resistor or blocking diode is required due to the internal MOSFET architecture. Thermal feedback regulates charge current to limit the die temperature during high power operation or high ambient temperature conditions.

When the input supply (wall adapter or USB supply) is removed, the LTC4069 automatically enters a low current state, dropping battery drain current to less than  $1\mu$ A. With power applied, LTC4069 can be put into shutdown mode, reducing the supply current to less than  $20\mu$ A.

The LTC4069 also includes automatic recharge, low-battery charge conditioning (trickle charging), soft-start (to limit inrush current) and an NTC thermistor input used to monitor battery temperature.

The LTC4069 is available in a tiny 6-lead, low profile  $(0.75 \text{mm}) 2 \text{mm} \times 2 \text{mm}$  DFN package.

### **FEATURES**

- Complete Linear Charger in 2mm × 2mm DFN Package
- C/10 Charge Current Detection Output
- Timer Charge Termination
- Charge Current Programmable up to 750mA with 5% Accuracy
- No External MOSFET, Sense Resistor or Blocking Diode Required
- NTC Thermistor Input for Temperature Qualified Charging
- Preset 4.2V Float Voltage with 0.6% Accuracy
- Constant-Current/Constant-Voltage Operation with Thermal Feedback to Maximize Charge Rate Without Risk of Overheating
- Charge Current Monitor Output for Gas Gauging
- Automatic Recharge
- Charges Single Cell Li-Ion Batteries Directly from USB Port
- 20µA Supply Current in Shutdown Mode
- Soft-Start Limits Inrush Current
- Tiny 6-Lead (2mm × 2mm) DFN Package

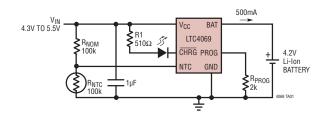
# **APPLICATIONS**

- Wireless PDAs
- Cellular Phones
- Portable Electronics

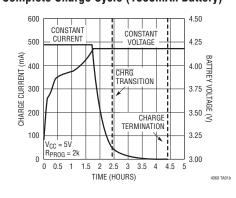
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# TYPICAL APPLICATION

Standalone Li-Ion Battery Charger



#### Complete Charge Cycle (1000mAh Battery)



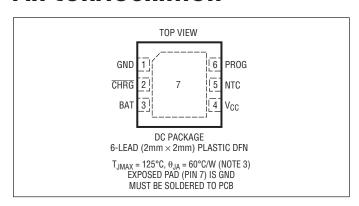


# **ABSOLUTE MAXIMUM RATINGS**

#### (Note 1)

| $V_{CC}$   |
|--|
| t < 1ms and Duty Cycle < 1%0.3V to 7             |
| Steady State0.3V to 6                            |
| BAT, CHRG0.3V to 6                               |
| PROG, NTC $-0.3V$ to $V_{CC} + 0.3V$             |
| BAT Short-Circuit DurationContinuou              |
| BAT Pin Current 800m/                            |
| PROG Pin Current 800µ/                           |
| Junction Temperature (Note 6) 125°C              |
| Operating Temperature Range (Note 2)40°C to 85°C |
| Storage Temperature Range65°C to 125°C           |

# PIN CONFIGURATION



# ORDER INFORMATION

| LEAD FREE FINISH | TAPE AND REEL    | PART MARKING | PACKAGE DESCRIPTION            | TEMPERATURE RANGE |
|------------------|------------------|--------------|--------------------------------|-------------------|
| LTC4069EDC#PBF   | LTC4069EDC#TRPBF | LBZX         | 6-Lead (2mm X 2mm) Plastic DFN | -40°C to 85°C     |

Consult LTC Marketing for parts specified with wider operating temperature ranges. Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/

For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/

# **ELECTRICAL CHARACTERISTICS**

The  $\bullet$  denotes specifications which apply over the full operating temperature range, otherwise specifications are  $T_A = 25^{\circ}C$ .  $V_{CC} = 5V$ ,  $V_{BAT} = 3.8V$ ,  $V_{NTC} = 0V$  unless otherwise specified. (Note 2)

| SYMBOL              | PARAMETER  | CONDITIONS   |   | MIN            | TYP        | MAX            | UNITS    |
|---------------------|--|--|---|----------------|------------|----------------|----------|
| $\overline{V_{CC}}$ | V <sub>CC</sub> Supply Voltage                         | (Note 4)   | • | 3.75           |            | 5.5            | V        |
| I <sub>CC</sub>     | Quiescent V <sub>CC</sub> Supply Current               | V <sub>BAT</sub> = 4.5V (Forces I <sub>BAT</sub> and I <sub>PROG</sub> = 0)  | • |                | 120        | 250            | μА       |
| I <sub>CCMS</sub>   | V <sub>CC</sub> Supply Current in Shutdown             | Float PROG   | • |                | 20         | 40             | μΑ       |
| I <sub>CCUV</sub>   | V <sub>CC</sub> Supply Current in Undervoltage Lockout | $V_{CC} < V_{BAT}$ , $V_{CC} = 3.5V$ , $V_{BAT} = 4V$  | • |                | 6          | 11             | μΑ       |
| V <sub>FLOAT</sub>  | V <sub>BAT</sub> Regulated Output Voltage              | I <sub>BAT</sub> = 2mA<br>I <sub>BAT</sub> = 2mA, 0°C < T <sub>A</sub> < 85°C  |   | 4.375<br>4.358 | 4.2<br>4.2 | 4.225<br>4.242 | V        |
| I <sub>BAT</sub>    | BAT Pin Current  | R <sub>PROG</sub> = 10k (0.1%), Current Mode<br>R <sub>PROG</sub> = 2k (0.1%), Current Mode  | • | 88<br>475      | 100<br>500 | 112<br>525     | mA<br>mA |
| I <sub>BMS</sub>    | Battery Drain Current in Shutdown Mode                 | Floating PROG, V <sub>CC</sub> > V <sub>BAT</sub>  | • | -1             | 0          | 1              | μΑ       |
| I <sub>BUV</sub>    | Battery Drain Current in Undervoltage<br>Lockout       | V <sub>CC</sub> = 3.5V, V <sub>BAT</sub> = 4V  | • | 0              | 1          | 4              | μА       |
| V <sub>UVLO</sub>   | V <sub>CC</sub> Undervoltage Lockout Voltage           | V <sub>CC</sub> Rising<br>V <sub>CC</sub> Falling  | • | 3.4<br>2.8     | 3.6<br>3   | 3.8<br>3.2     | V<br>V   |
| V <sub>PROG</sub>   | PROG Pin Voltage                                       | R <sub>PROG</sub> = 2k, I <sub>PROG</sub> = 500μA<br>R <sub>PROG</sub> = 10k, I <sub>PROG</sub> = 100μA                                  | • | 0.98<br>0.98   | 1<br>1     | 1.02<br>1.02   | V        |
| V <sub>ASD</sub>    | Automatic Shutdown Threshold Voltage                   | (V <sub>CC</sub> – V <sub>BAT</sub> ), V <sub>CC</sub> Low to High<br>(V <sub>CC</sub> – V <sub>BAT</sub> ), V <sub>CC</sub> High to Low |   | 60<br>15       | 80<br>30   | 100<br>45      | mV<br>mV |



# **ELECTRICAL CHARACTERISTICS**

The  $\bullet$  denotes specifications which apply over the full operating temperature range, otherwise specifications are  $T_A = 25^{\circ}C$ .  $V_{CC} = 5V$ ,  $V_{BAT} = 3.8V$ ,  $V_{NTC} = 0V$  unless otherwise specified. (Note 2)

| SYMBOL                                | PARAMETER   | CONDITIONS   |   | MIN       | TYP   | MAX        | UNITS    |
|---------------------------------------|---|--|---|-----------|---|------------|----------|
| I <sub>PROG</sub>                     | PROG Pin Pull-Up Current  | V <sub>PROG</sub> > 1V   |   |           | 3   |            | μА       |
| V <sub>MS, PROG</sub>                 | PROG Shutdown Threshold Voltage                                     | V <sub>PROG</sub> Rising   | • | 3.7       | 4   | 4.3        | V        |
| t <sub>SS</sub>                       | Soft-Start Time   |  |   |           | 170   |            | μѕ       |
| I <sub>TRKL</sub>                     | Trickle Charge Current  | V <sub>BAT</sub> = 2V, R <sub>PROG</sub> = 2k (0.1%)   |   | 35        | 50  | 65         | mA       |
| $V_{TRKL}$                            | Trickle Charge Threshold Voltage                                    | V <sub>BAT</sub> Rising  | • | 2.7       | 2.9   | 3.05       | V        |
| V <sub>TRHYS</sub>                    | Trickle Charge Hysteresis Voltage                                   |  |   |           | 90  |            | mV       |
| $\Delta V_{RECHRG}$                   | Recharge Battery Threshold Voltage                                  | V <sub>FLOAT</sub> – V <sub>RECHRG</sub> , 0°C < T <sub>A</sub> < 85°C                               |   | 70        | 100   | 130        | mV       |
| $\Delta V_{UVCL1}$ $\Delta V_{UVCL2}$ | (V <sub>CC</sub> – V <sub>BAT</sub> ) Undervoltage Current<br>Limit | I <sub>BAT</sub> = 90% Programmed Charge Current<br>I <sub>BAT</sub> = 10% Programmed Charge Current |   | 180<br>90 | 220<br>125  | 330<br>150 | mV<br>mV |
| t <sub>TIMER</sub>                    | Termination Timer   |  | • | 3         | 4.5   | 6          | Hrs      |
|                                       | Recharge Timer  |  | • | 1.5       | 2.25  | 3          | Hrs      |
|                                       | Low-Battery Trickle Charge Time                                     | V <sub>BAT</sub> = 2.5V  | • | 0.75      | 1.125   | 1.5        | Hrs      |
| $V_{\overline{CHRG}}$                 | CHRG Pin Output Low Voltage   | I <sub>CHRG</sub> = 5mA  | • |           | 60  | 105        | mV       |
| I <sub>CHRG</sub>                     | CHRG Pin Leakage Current  | $V_{BAT} = 4.5V$ , $V_{\overline{CHRG}} = 5V$  | • |           | 0   | 1          | μА       |
| I <sub>C/10</sub>                     | End of Charge Indication Current Level                              | R <sub>PROG</sub> = 2k (Note 5)  | • | 0.08      | 0.095   | 0.11       | mA/mA    |
| T <sub>LIM</sub>                      | Junction Temperature in Constant<br>Temperature Mode                |  |   |           | 115   |            | °C       |
| R <sub>ON</sub>                       | Power FET "ON" Resistance<br>(Between V <sub>CC</sub> and BAT)      | I <sub>BAT</sub> = 350mA   |   |           | 450   |            | mΩ       |
| f <sub>BADBAT</sub>                   | Defective Battery Detection CHRG Pulse Frequency                    |  |   |           | 2   |            | Hz       |
| D <sub>BADBAT</sub>                   | Defective Battery Detection CHRG Pulse Frequency Duty Ratio         |  |   |           | 75  |            | %        |
| I <sub>NTC</sub>                      | NTC Pin Current   | V <sub>NTC</sub> = 2.5V  |   |           |   | 1          | μА       |
| V <sub>COLD</sub>                     | Cold Temperature Fault Threshold<br>Voltage                         | Rising Voltage Threshold<br>Hysteresis   |   |           | 0.76 • V <sub>CC</sub><br>0.015 • V <sub>CC</sub> |            | V        |
| V <sub>HOT</sub>                      | Hot Temperature Fault Threshold<br>Voltage                          | Falling Voltage Threshold<br>Hysteresis  |   |           | 0.35 • V <sub>CC</sub><br>0.017 • V <sub>CC</sub> |            | V        |
| V <sub>NTC-DIS</sub>                  | NTC Disable Threshold Voltage                                       | Falling Threshold; V <sub>CC</sub> = 5V  |   |           | 82  |            | mV       |
| V <sub>DIS-HYS</sub>                  | NTC Disable Hysteresis Voltage                                      |  |   |           | 50  |            | mV       |
| f <sub>NTC</sub>                      | Fault Temperature CHRG Pulse Frequency                              |  |   |           | 2   |            | Hz       |
| D <sub>NTC</sub>                      | Fault Temperature CHRG Pulse Frequency<br>Duty Ratio                |  |   |           | 25  |            | %        |

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

**Note 2:** The LTC4069 is guaranteed to meet performance specifications from  $0^{\circ}$ C to  $85^{\circ}$ C. Specifications over the  $-40^{\circ}$ C to  $85^{\circ}$ C operating temperature range are assured by design, characterization and correlation with statistical process controls.

**Note 3:** Failure to solder the exposed backside of the package to the PC board ground plane will result in a thermal resistance much higher than rated.

**Note 4:** Although the LTC4069 functions properly at 3.75V, full charge current requires an input voltage greater than the desired final battery voltage per the  $\Delta V_{UVCL1}$  specification.

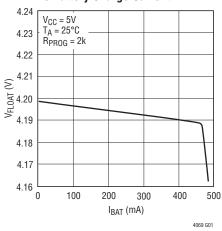
Note 5:  $I_{\text{C/10}}$  is expressed as a fraction of measured full charge current with indicated PROG resistor.

**Note 6:** This IC includes overtemperature protection that is intended to protect the device during momentary overload conditions. Junction temperature will exceed 125°C when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature may impair device reliability.

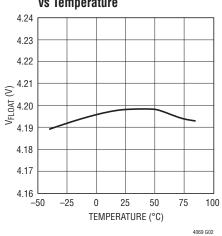


# TYPICAL PERFORMANCE CHARACTERISTICS

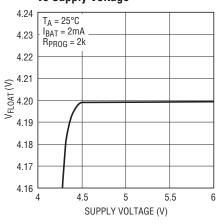
# Battery Regulation (Float) Voltage vs Battery Charge Current



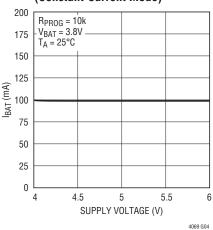
# Battery Regulation (Float) Voltage vs Temperature



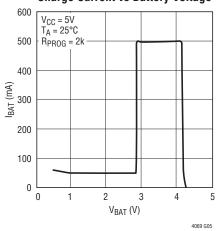
Battery Regulation (Float) Voltage vs Supply Voltage



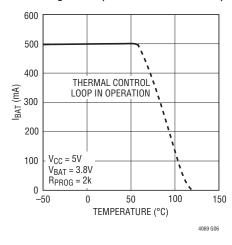
Charge Current vs Supply Voltage (Constant-Current Mode)



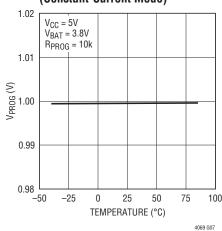
**Charge Current vs Battery Voltage** 



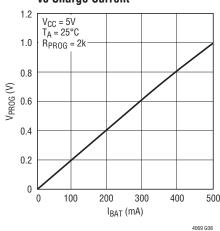
Charge Current vs Ambient
Temperature with Thermal
Regulation (Constant-Current Mode)



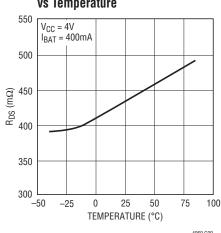
PROG Pin Voltage vs Temperature (Constant-Current Mode)



PROG Pin Voltage vs Charge Current



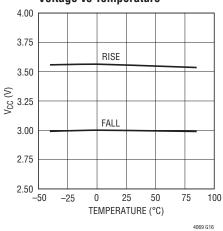
Power FET On-Resistance vs Temperature



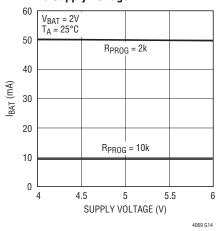


# TYPICAL PERFORMANCE CHARACTERISTICS

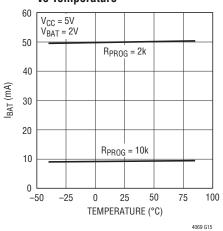
#### Undervoltage Lockout Threshold Voltage vs Temperature



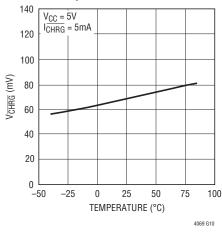
# Trickle Charge Current vs Supply Voltage



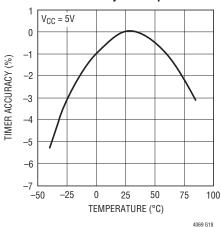
# Trickle Charge Current vs Temperature



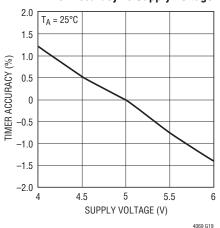
# CHRG Pin Output Low Voltage vs Temperature



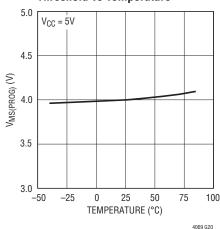
#### Timer Accuracy vs Temperature



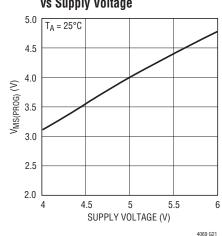
Timer Accuracy vs Supply Voltage



#### PROG Pin Shutdown Voltage Threshold vs Temperature



# PROG Pin Shutdown Voltage vs Supply Voltage





### PIN FUNCTIONS

GND (Pin 1): Ground.

**CHRG** (Pin 2): Open-Drain Charge Status Output. The charge status indicator pin has three states: pull-down, pulse at 2Hz and high impedance state. This output can be used as a logic interface or as an LED driver. When the battery is being charged, the  $\overline{CHRG}$  pin is pulled low by an internal N-channel MOSFET. When the charge current drops to 10% of the full-scale current, the  $\overline{CHRG}$  pin is forced to a high impedance state. If the battery voltage remains below 2.9V for one quarter of the charge time, the battery is considered defective and the  $\overline{CHRG}$  pin pulses at a frequency of 2Hz (75% duty cycle). When the NTC pin voltage rises above 0.76 • V<sub>CC</sub> or drops below 0.35 • V<sub>CC</sub>, the  $\overline{CHRG}$  pin pulses at a frequency of 2Hz (25% duty cycle).

**BAT (Pin 3):** Charge Current Output. Provides charge current to the battery and regulates the final float voltage to 4.2V. An internal precision resistor divider on this pin sets the float voltage and is disconnected in shutdown mode.

**VCC** (**Pin 4**): Positive Input Supply Voltage. This pin provides power to the charger.  $V_{CC}$  can range from 3.75V to 5.5V. This pin should be bypassed with at least a 1µF capacitor. When  $V_{CC}$  is within 32mV of the BAT pin voltage, the LTC4069 enters shutdown mode, dropping  $I_{BAT}$  to about 1µA.

**NTC** (**Pin 5**): Input to the NTC (Negative Temperature Coefficient) Thermistor Temperature Monitoring Circuit. Under normal operation, connect a thermistor from the NTC pin to ground and a resistor of equal value from the NTC pin to  $V_{CC}$ . When the voltage at this pin drops below  $0.35 \cdot V_{CC}$  at hot temperatures or rises above  $0.76 \cdot V_{CC}$  at cold, charging is suspended, the internal timer is frozen and the  $\overline{CHRG}$  pin output will start to pulse at 2Hz. Pulling this pin below  $0.016 \cdot V_{CC}$  disables the NTC feature. There is approximately 3°C of temperature hysteresis associated with each of the input comparator's thresholds.

**PROG** (Pin 6): Charge Current Program and Charge Current Monitor Pin. Connecting a 1% resistor, R<sub>PROG</sub>, to ground programs the charge current. When charging in constant-current mode, this pin servos to 1V. In all modes, the voltage on this pin can be used to measure the charge current using the following formula:

$$I_{BAT} = \frac{V_{PROG}}{R_{PROG}} \bullet 1000$$

Floating the PROG pin puts the charger in shutdown mode. In shutdown mode, the LTC4069 has less than  $20\mu A$  supply current and about  $1\mu A$  battery drain current.

**Exposed Pad (Pin 7):** Ground. The Exposed Pad must be soldered to the PCB ground to provide both electrical contact and rated thermal performance.

# SIMPLIFIED BLOCK DIAGRAM

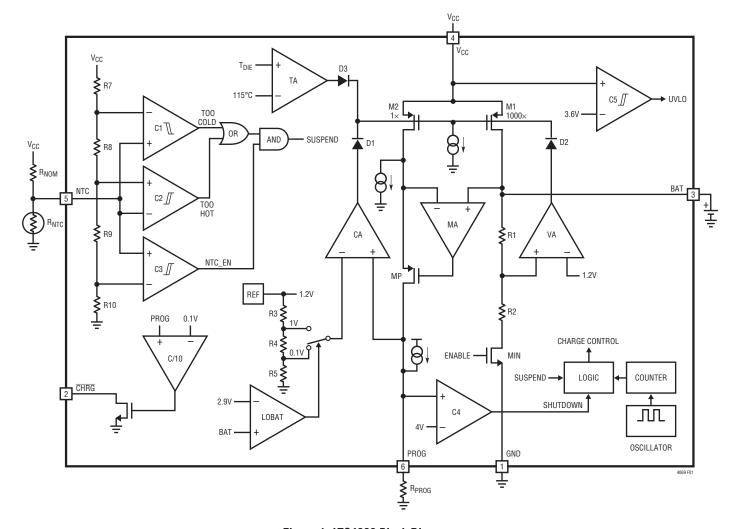


Figure 1. LTC4069 Block Diagram

# **OPERATION**

The LTC4069 is a linear battery charger designed primarily for charging single cell lithium-ion batteries. Featuring an internal P-channel power MOSFET, the charger uses a constant-current/constant-voltage charge algorithm with programmable current. Charge current can be programmed up to 750mA with a final float voltage accuracy of ±0.6%. The CHRG open-drain status output indicates if C/10 has been reached. No blocking diode or external sense resistor is required; thus, the basic charger circuit requires only two external components. An internal termination timer and trickle charge low-battery conditioning adhere to battery manufacturer safety guidelines. Furthermore, the

LTC4069 is capable of operating from a USB power source.

An internal thermal limit reduces the programmed charge current if the die temperature attempts to rise above a preset value of approximately 115°C. This feature protects the LTC4069 from excessive temperature and allows the user to push the limits of the power handling capability of a given circuit board without risk of damaging the LTC4069 or external components. Another benefit of the LTC4069 thermal limit is that charge current can be set according to typical, not worst-case, ambient



temperatures for a given application with the assurance that the charger will automatically reduce the current in worst-case conditions.

The charge cycle begins when the voltage at the  $V_{CC}$  pin rises above 3.5V and approximately 80mV above the BAT pin voltage, a 1% program resistor is connected from the PROG pin to ground and the NTC pin voltage stays between 0.76 •  $V_{CC}$  and 0.35 •  $V_{CC}$  or below 0.016 •  $V_{CC}$ .

If the BAT pin voltage is below 2.9V, the charger goes into trickle charge mode, charging the battery at one-tenth the programmed charge current to bring the cell voltage up to a safe level for charging. If the BAT pin voltage is above 4.1V, the charger will not charge the battery as the cell is near full capacity. Otherwise, the charger goes into the fast charge constant-current mode.

When the BAT pin approaches the final float voltage (4.2V), the LTC4069 enters constant-voltage mode and the charge current begins to decrease. When the current drops to 10% of the full-scale charge current, an internal comparator turns off the N-channel MOSFET on the CHRG pin and the pin assumes a high impedance state.

An internal timer sets the total charge time,  $t_{TIMER}$  (typically 4.5 hours). When this time elapses, the charge cycle terminates and the  $\overline{CHRG}$  pin assumes a high impedance state. The charge cycle will automatically restart if the BAT pin voltage falls below  $V_{RECHRG}$  (typically 4.1V). To manually restart the charge cycle, remove the input voltage and reapply it, or momentarily float the PROG pin and reconnect it.

#### **Programming Charge Current**

The charge current is programmed using a single resistor from the PROG pin to ground. The battery charge current is 1000 times the current out of the PROG pin. The program resistor and the charge current are calculated using the following equations:

$$R_{PROG} = 1000 \bullet \frac{1V}{I_{CHG}}, I_{CHG} = \frac{1000V}{R_{PROG}}$$

The charge current out of the BAT pin can be determined at any time by monitoring the PROG pin voltage and using the following equation:

$$I_{BAT} = \frac{V_{PROG}}{R_{PROG}} \bullet 1000$$

#### **Undervoltage Lockout (UVLO)**

An internal undervoltage lockout circuit monitors the input voltage and keeps the charger in undervoltage lockout until  $V_{CC}$  rises above 3.6V and approximately 80mV above the BAT pin voltage. The 3.6V UVLO circuit has a built-in hysteresis of approximately 0.6V and the automatic shutdown threshold has a built-in hysteresis of approximately 50mV. During undervoltage lockout conditions, maximum battery drain current is  $4\mu A$  and maximum supply current is  $11\mu A$ .

#### Shutdown Mode

The LTC4069 can be disabled by floating the PROG pin. In shutdown mode, the battery drain current is reduced to less than 1µA and the supply current to about 20µA.

#### **Timer and Recharge**

The LTC4069 has an internal termination timer that starts when an input voltage greater than the undervoltage lockout threshold is applied to  $V_{CC}$ , or when leaving shutdown and the battery voltage is less than the recharge threshold.

At power-up or when exiting shutdown, if the battery voltage is less than the recharge threshold, the charge time is set to 4.5 hours. If the battery temperature is either too high or too low, the timer will pause until the battery returns to normal temperature. If the battery is greater than the recharge threshold at power-up or when exiting shutdown, the timer will not start and charging is prevented since the battery is at or near full capacity.

Once the charge cycle terminates, the LTC4069 continuously monitors the BAT pin voltage using a comparator with a 2ms filter time. When the battery voltage falls below 4.1V (which corresponds to 80% to 90% battery capacity), a new charge cycle is initiated and a 2.25 hour timer begins. This ensures that the battery is kept at, or near, a fully charged condition and eliminates the need for periodic charge cycle initiations. Also, if the battery voltage does



not exceed the recharge threshold voltage when the timer ends, the timer resets and a 2.25 hour recharge cycle begins. The  $\overline{\text{CHRG}}$  output assumes a strong pull-down state during recharge cycles until C/10 is reached when it transitions to a high impendance state.

#### **Trickle Charge and Defective Battery Detection**

At the beginning of a charge cycle, if the battery voltage is low (below 2.9V), the charger goes into trickle charge, reducing the charge current to 10% of the full-scale current. If the low-battery voltage persists for one quarter of the total time (1.125 hour), the battery is assumed to be defective, the charge cycle is terminated and the CHRG pin output pulses at a frequency of 2Hz with a 75% duty cycle. If for any reason the battery voltage rises above 2.9V, the charge cycle will be restarted. To restart the charge cycle (i.e., when the defective battery is replaced with a discharged battery), simply remove the input voltage and reapply it or momentarily float the PROG pin and reconnect it.

#### **CHRG** Status Output Pin

The charge status indicator pin has three states: pull-down, pulse at 2Hz (see Trickle Charge and Defective Battery Detection and Battery Temperature Monitoring) and high impedance. The pull-down state indicates that the LTC4069 is in a charge cycle. A high impedance state indicates that the charge current has dropped below 10% of the full-scale current or the LTC4069 is disabled. Figure 2 shows the CHRG status under various conditions.

### **Charge Current Soft-Start and Soft-Stop**

The LTC4069 includes a soft-start circuit to minimize the inrush current at the start of a charge cycle. When a charge cycle is initiated, the charge current ramps from zero to the full-scale current over a period of approximately 170µs. Likewise, internal circuitry slowly ramps the charge current from full-scale to zero when the charger is shut off or self terminates. This has the effect of minimizing the transient current load on the power supply during start-up and charge termination.

### Constant-Current/Constant-Voltage/ Constant-Temperature

The LTC4069 uses a unique architecture to charge a battery in a constant-current, constant-voltage and constant-temperature fashion. Figure 1 shows a Simplified Block Diagram of the LTC4069. Three of the amplifier feedback loops shown control the constant-current (CA), constant-voltage (VA), and constant-temperature (TA) modes. A fourth amplifier feedback loop (MA) is used to increase the output impedance of the current source pair, M1 and M2 (note that M1 is the internal P-channel power MOSFET). It ensures that the drain current of M1 is exactly 1000 times greater than the drain current of M2.

Amplifiers CA and VA are used in separate feedback loops to force the charger into constant-current or constant-voltage mode, respectively. Diodes D1 and D2 provide priority to either the constant-current or constant-voltage loop, whichever is trying to reduce the charge current the most. The output of the other amplifier saturates low which effectively removes its loop from the system. When in constant-current mode, CA servos the voltage at the PROG pin to be precisely 1V. VA servos its inverting input to an internal reference voltage when in constant-voltage mode and the internal resistor divider, made up of R1 and R2, ensures that the battery voltage is maintained at 4.2V. The PROG pin voltage gives an indication of the charge current during constant-voltage mode as discussed in "Programming Charge Current".

Transconductance amplifier, TA, limits the die temperature to approximately 115°C when in constant-temperature mode. Diode D3 ensures that TA does not affect the charge current when the die temperature is below approximately 115°C. The PROG pin voltage continues to give an indication of the charge current.

In typical operation, the charge cycle begins in constant-current mode with the current delivered to the battery equal to 1000V/R<sub>PROG</sub>. If the power dissipation of the LTC4069 results in the junction temperature approaching 115°C, the amplifier (TA) will begin decreasing the charge current to limit the die temperature to approximately 115°C. As the battery voltage rises, the LTC4069 either returns to constant-current mode or enters constant-voltage mode straight from constant-temperature mode.





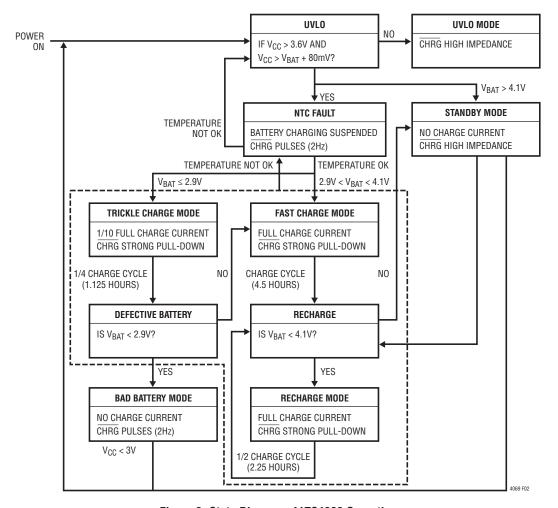


Figure 2. State Diagram of LTC4069 Operation

Regardless of mode, the voltage at the PROG pin is proportional to the current delivered to the battery.

## **Battery Temperature Monitoring via NTC**

The battery temperature is measured by placing a negative temperature coefficient (NTC) thermistor close to the battery pack. The NTC circuitry is shown in Figure 3.

To use this feature, connect the NTC thermistor,  $R_{NTC}$ , between the NTC pin and ground and a resistor,  $R_{NOM}$ , from the NTC pin to  $V_{CC}$ .  $R_{NOM}$  should be a 1% resistor with a value equal to the value of the chosen NTC thermistor at 25°C (this value is 100k for a Vishay NTHS0603N01N1003J thermistor). The LTC4069 goes into hold mode when the value of the NTC thermistor drops to 0.53 times the value of  $R_{NOM}$ , which corresponds to approximately 40°C,

and when the value of the NTC thermistor increases to 3.26 times the value of  $R_{NOM}, \$ which corresponds to approximately 0°C. Hold mode freezes the timer and stops the charge cycle until the thermistor indicates a return to a valid temperature. For a Vishay NTHS0603N01N1003J thermistor, this value is 32.6k which corresponds to approximately 0°C. The hot and cold comparators each have approximately 3°C of hysteresis to prevent oscillation about the trip point.

When the charger is in Hold mode (battery temperature is either too hot or too cold) the  $\overline{\text{CHRG}}$  pin pulses in a 2Hz, 25% duty cycle frequency unless the charge task is finished or the battery is assumed to be defective. If the NTC pin is grounded, the NTC function will be disabled

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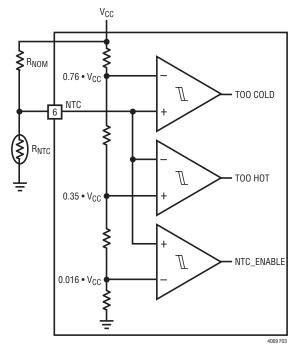


Figure 3. NTC Circuit Information

### APPLICATIONS INFORMATION

## **Undervoltage Charge Current Limiting (UVCL)**

The LTC4069 includes undervoltage charge ( $\Delta V_{UVCL1}$ ) current limiting that prevents full charge current until the input supply voltage exceeds approximately 200mV above the battery voltage. This feature is particularly useful if the LTC4069 is powered from a supply with long leads (or any relatively high output impedance).

For example, USB-powered systems tend to have highly variable source impedances (due primarily to cable quality and length). A transient load combined with such impedance can easily trip the UVLO threshold and turn the charger off unless undervoltage charge current limiting is implemented.

Consider a situation where the LTC4069 is operating under normal conditions and the input supply voltage begins to droop (e.g., an external load drags the input supply down). If the input voltage reaches  $V_{BAT} + \Delta V_{UVCL1}$  (approximately 220mV above the battery voltage), undervoltage charge current limiting will begin to reduce the charge current in an attempt to maintain  $\Delta V_{UVCL1}$  between the  $V_{CC}$  input and the BAT output of the IC. The LTC4069 will continue

to operate at the reduced charge current until the input supply voltage is increased or constant voltage mode reduces the charge current further.

### **Operation from Current Limited Wall Adapter**

By using a current limited wall adapter as the input supply, the LTC4069 dissipates significantly less power when programmed for a current higher than the limit of the supply as compared to using a non-current limited supply at the same charge current.

Consider a situation where an application demands a 600mA charge current for an 800mAh Li-Ion battery. If a typical 5V (non-current limited) input supply is used, the charger's peak power dissipation can exceed 1W.

Now consider the same scenario, but with a 5V input supply with a 600mA current limit. To take advantage of the current limited supply, it is necessary to program the LTC4069 to charge at a current above 600mA. Assume that the LTC4069 is programmed for 750mA (i.e.,  $R_{PROG} = 1.33k$ ) to ensure that part tolerances maintain a programmed current higher than 600mA. Since the





LTC4069 will demand a charge current higher than the current limit of the voltage supply, the supply voltage will drop to the battery voltage plus 600mA times the "on" resistance of the internal PFET. The "on" resistance of the LTC4069 power device is approximately  $450m\Omega$  with a 5V supply. The actual "on" resistance will be slightly higher due to the fact that the input supply will drop to less than 5V. The power dissipated during this phase of charging is less than 240mW. That is a 76% improvement over the non-current limited supply power dissipation.

#### **USB** and Wall Adapter Power

Although the LTC4069 allows charging from a USB port, a wall adapter can also be used to charge Li-lon batteries. Figure 4 shows an example of how to combine wall adapter and USB power inputs. A P-channel MOSFET, MP1, is used to prevent back conducting into the USB port when a wall adapter is present and Schottky diode, D1, is used to prevent USB power loss through the 1k pull-down resistor.

Typically a wall adapter can supply significantly more current than the 500mA-limited USB port. Therefore, an N-channel MOSFET, MN1, and an extra program resistor are used to increase the charge current to 750mA when the wall adapter is present.

#### **Stability Considerations**

The LTC4069 contains two control loops: constant-voltage and constant-current. The constant-voltage loop is stable without any compensation when a battery is connected with low impedance leads. Excessive lead length, however, may add enough series inductance to require a bypass

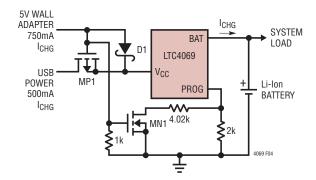


Figure 4. Combining Wall Adapter and USB Power

capacitor of at least 1µF from BAT to GND. Furthermore, a 4.7µF capacitor with a  $0.2\Omega$  to  $1\Omega$  series resistor from BAT to GND is required to keep ripple voltage low when the battery is disconnected.

High value capacitors with very low ESR (especially ceramic) may reduce the constant-voltage loop phase margin. Ceramic capacitors up to  $22\mu F$  may be used in parallel with a battery, but larger ceramics should be decoupled with  $0.2\Omega$  to  $1\Omega$  of series resistance.

In constant-current mode, the PROG pin is in the feedback loop, not the battery. Because of the additional pole created by the PROG pin capacitance, capacitance on this pin must be kept to a minimum. With no additional capacitance on the PROG pin, the charger is stable with program resistor values as high as 25k. However, additional capacitance on this node reduces the maximum allowed program resistor. The pole frequency at the PROG pin should be kept above 100kHz. Therefore, if the PROG pin is loaded with a capacitance,  $C_{PROG}$ , the following equation should be used to calculate the maximum resistance value for  $R_{PROG}$ :

$$R_{PROG} \le \frac{1}{2\pi \cdot 10^5 \cdot C_{PROG}}$$

Average, rather than instantaneous, battery current may be of interest to the user. For example, if a switching power supply operating in low current mode is connected in parallel with the battery, the average current being pulled out of the BAT pin is typically of more interest than the instantaneous current pulses. In such a case, a simple RC filter can be used on the PROG pin to measure the average

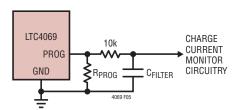


Figure 5. Isolating Capacitive Load on the PROG Pin and Filtering

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battery current as shown in Figure 5. A 10k resistor has been added between the PROG pin and the filter capacitor to ensure stability.

#### **Power Dissipation**

The conditions that cause the LTC4069 to reduce charge current through thermal feedback can be approximated by considering the power dissipated in the IC. For high charge currents, the LTC4069 power dissipation is approximately:

$$P_D = (V_{CC} - V_{BAT}) \cdot I_{BAT}$$

where  $P_D$  is the power dissipated,  $V_{CC}$  is the input supply voltage,  $V_{BAT}$  is the battery voltage and  $I_{BAT}$  is the charge current. It is not necessary to perform any worst-case power dissipation scenarios because the LTC4069 will automatically reduce the charge current to maintain the die temperature at approximately 115°C. However, the approximate ambient temperature at which the thermal feedback begins to protect the IC is:

$$T_{A} = 115^{\circ}C - P_{D} \bullet \theta_{JA}$$

$$T_{A} = 115^{\circ}C - (V_{CC} - V_{BAT}) \bullet I_{BAT} \bullet \theta_{JA}$$

Example: Consider an LTC4069 operating from a 5V wall adapter providing 750mA to a 3.6V Li-lon battery. The ambient temperature above which the LTC4069 will begin to reduce the 750mA charge current is approximately:

$$T_A = 115^{\circ}\text{C} - (5\text{V} - 3.6\text{V}) \cdot (750\text{mA}) \cdot 60^{\circ}\text{C/W}$$
  
 $T_A = 115^{\circ}\text{C} - (1.05\text{W} \cdot 60^{\circ}\text{C/W}) = 115^{\circ}\text{C} - 63^{\circ}\text{C}$   
 $T_A = 52^{\circ}\text{C}$ 

The LTC4069 can be used above 70°C, but the charge current will be reduced from 750mA. The approximate current at a given ambient temperature can be calculated:

$$I_{BAT} = \frac{115^{\circ}C - T_{A}}{\left(V_{CC} - V_{BAT}\right) \bullet \theta_{JA}}$$

Using the previous example with an ambient temperature of 73°C, the charge current will be reduced to approximately:

$$I_{BAT} = \frac{115^{\circ}C - 73^{\circ}C}{(5V - 3.6V) \cdot 60^{\circ}C/W} = \frac{42^{\circ}C}{84^{\circ}C/A} = 500\text{mA}$$

Furthermore, the voltage at the PROG pin will change proportionally with the charge current as discussed in the Programming Charge Current section.

It is important to remember that LTC4069 applications do not need to be designed for worst-case thermal conditions since the IC will automatically limit power dissipation when the junction temperature reaches approximately 115°C.

#### **Board Layout Considerations**

In order to deliver maximum charge current under all conditions, it is critical that the exposed metal pad on the backside of the LTC4069 package is soldered to the PC board copper and extending out to relatively large copper areas or internal copper layers connected using vias. Correctly soldered to a 2500mm² double-sided 1 oz. copper board the LTC4069 has a thermal resistance of approximately 60°C/W. Failure to make thermal contact between the Exposed Pad on the backside of the package and the copper board will result in thermal resistances far greater than 60°C/W. As an example, a correctly soldered LTC4069 can deliver over 750mA to a battery from a 5V supply at room temperature. Without a backside thermal connection, this number could drop to less than 500mA.

# **V<sub>CC</sub>** Bypass Capacitor

Many types of capacitors can be used for input bypassing; however, caution must be exercised when using multi-layer ceramic capacitors. Because of the self-resonant and high Q characteristics of some types of ceramic capacitors, high voltage transients can be generated under some start-up conditions, such as connecting the charger input to a live power source. For more information, refer to Application Note 88.



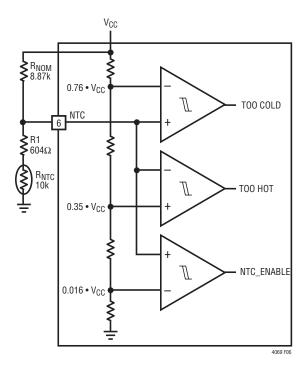


Figure 6. NTC Circuits

#### **Thermistors**

The LTC4069 NTC trip points are designed to work with thermistors whose resistance-temperature characteristics follow Vishay Dale's "R-T Curve 1." The Vishay NTHS0603N01N1003J is an example of such a thermistor. However, Vishay Dale has many thermistor products that follow the "R-T Curve 1" characteristic in a variety of sizes. Furthermore, any thermistor whose ratio of  $R_{COLD}$  to  $R_{HOT}$  is about 6 will also work (Vishay Dale R-T Curve 1 shows a ratio of  $R_{COLD}$  to  $R_{HOT}$  of 3.266/0.5325 = 6.13).

Designers may want to use thermistors whose room temperature value is different than 100k. Vishay Dale has a number of values of thermistor from 32k to 100k that follow the "R-T Curve 1." Using different R-T curves, such as Vishay Dale "R-T Curve 2", is also possible. This curve, combined with LTC4069 internal thresholds, gives temperature trip points of approximately  $-3^{\circ}\text{C}$  (falling) and 42°C (rising), a delta of 45°C. This delta in temperature can be moved in either direction by changing the value of  $R_{NOM}$  with respect to  $R_{NTC}$ . Increasing  $R_{NOM}$  will move both trip points to higher temperatures. To calculate

 $R_{\mbox{NOM}}$  for a shift to lower temperature for example, use the following equation:

$$R_{NOM} = \frac{R_{COLD}}{3.266} \cdot R_{NTC}$$
 at 25°C

where  $R_{COLD}$  is the resistance ratio of  $R_{NTC}$  at the desired cold temperature trip point. If you want to shift the trip points to higher temperatures use the following equation:

$$R_{NOM} = \frac{R_{HOT}}{0.5325} \bullet R_{NTC}$$
 at 25°C

where  $R_{HOT}$  is the resistance ratio of  $R_{NTC}$  at the desired hot temperature trip point.

Here is an example using a 10k R-T Curve 2 thermistor from Vishay Dale. The difference between the trip points is 45°C, from before, and we want the cold trip point to be 0°C, which would put the hot trip point at 45°C. The  $R_{NOM}$  needed is calculated as follows:

$$R_{NOM} = \frac{R_{COLD}}{3.266} \cdot R_{NTC} \text{ at } 25^{\circ}C$$
  
=  $\frac{2.816}{3.266} \cdot 10 \text{k} = 8.62 \text{k}$ 

The nearest 1% value for  $R_{NOM}$  is 8.66k. This is the value used to bias the NTC thermistor to get cold and hot trip points of approximately 0°C and 45°C respectively. To extend the delta between the cold and hot trip points, a resistor, R1, can be added in series with  $R_{NTC}$  (see Figure 6). The values of the resistors are calculated as follows:

$$\begin{split} R_{NOM} &= \frac{R_{COLD} - R_{HOT}}{3.266 - 0.5325} \\ R_1 &= \left(\frac{0.5325}{3.266 - 0.5325}\right) \bullet \left(R_{COLD} - R_{HOT}\right) - R_{HOT} \end{split}$$

where  $R_{NOM}$  is the value of the bias resistor and  $R_{HOT}$  and  $R_{COLD}$  are the values of  $R_{NTC}$  at the desired temperature trip points. Continuing the example from before with a desired trip point of 50°C:

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$$R_{NOM} = \frac{R_{COLD} - R_{HOT}}{3.266 - 0.5325} = \frac{10k \bullet \left(2.816 - 0.4086\right)}{3.266 - 0.5325}$$

= 8.8k, 8.87k is the nearest 1% value.

$$R_1 = 10k \cdot \left(\frac{0.5325}{3.266 - 0.5325}\right) \cdot \left(2.816 - 0.4086\right) - 0.4086$$

=  $604\Omega$ . 604 is the nearest 1% value.

#### **NTC Trip Point Error**

When a 1% resistor is used for  $R_{HOT}$ , the major error in the 40°C trip point is determined by the tolerance of the NTC thermistor. A typical 100k NTC thermistor has  $\pm 10\%$  tolerance. By looking up the temperature coefficient of the thermistor at 40°C, the tolerance error can be calculated in degrees centigrade. Consider the Vishay NTHS0603N01N1003J thermistor, which has a temperature coefficient of -4%/°C at 40°C. Dividing the tolerance by the temperature coefficient,  $\pm 5\%$ /(4%/°C) =  $\pm 1.25$ °C, gives the temperature error of the hot trip point.

The cold trip point error depends on the tolerance of the NTC thermistor and the degree to which the ratio of its value at 0°C and its value at 40°C varies from 6.14 to 1. Therefore, the cold trip point error can be calculated using the tolerance, TOL, the temperature coefficient of the thermistor at 0°C, TC (in %/°C), the value of the thermistor at 40°C,  $R_{COLD}$ , and the value of the thermistor at 40°C,  $R_{HOT}$ . The formula is:

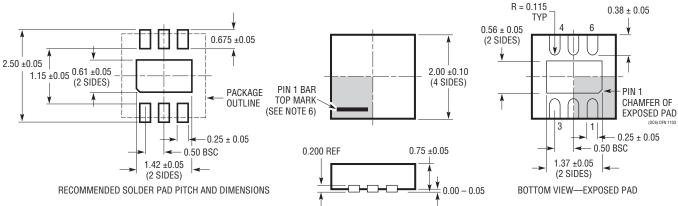
Temperature Error(°C) = 
$$\frac{\left(\frac{1+TOL}{6.14} \bullet \frac{R_{COLD}}{R_{HOT}} - 1\right) \bullet 100}{TC}$$

For example, the Vishay NTHS0603N01N1003J thermistor with a tolerance of  $\pm 5\%$ , TC of -5%/°C and R<sub>COLD</sub>/R<sub>HOT</sub> of 6.13, has a cold trip point error of:

Temperature Error(°C) = 
$$\frac{\left(\frac{1+0.05}{6.14} \bullet 6.13 - 1\right) \bullet 100}{-5}$$
$$= -0.95 °C, 1.05 °C$$

# PACKAGE DESCRIPTION

#### DC Package 6-Lead Plastic DFN (2mm × 2mm) (Reference LTC DWG # 05-08-1703)



#### NOTE:

- 1. DRAWING TO BE MADE A JEDEC PACKAGE OUTLINE MO-229 VARIATION OF (WCCD-2)
- 2. DRAWING NOT TO SCALE
- 3. ALL DIMENSIONS ARE IN MILLIMETERS
- 4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
- 5. EXPOSED PAD SHALL BE SOLDER PLATED
- 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE



# **RELATED PARTS**

| PART NUMBER      | DESCRIPTION   | COMMENTS   |
|------------------|---|--|
| Battery Chargers |   |  |
| LTC1734          | Lithium-Ion Linear Battery Charger in ThinSOT™                                      | Simple ThinSOT Charger, No Blocking Diode, No Sense Resistor Needed  |
| LTC1734L         | Lithium-Ion Linear Battery Charger in ThinSOT                                       | Low Current Version of LTC1734, 50mA ≤ I <sub>CHRG</sub> ≤ 180mA   |
| LTC4002          | Switch Mode Lithium-Ion Battery Charger   | Standalone, $4.7V \leq V_{\text{IN}} \leq 24V,500\text{kHz}$ Frequency, 3 Hour Charge Termination  |
| LTC4050          | Lithium-Ion Linear Battery Charger Controller                                       | Features Preset Voltages, C/10 Charger Detection and Programmable Timer, Input Power Good Indication, Thermistor Interface                         |
| LTC4052          | Monolithic Lithium-Ion Battery Pulse Charger  | No Blocking Diode or External Power FET Required, ≤1.5A Charge Current   |
| LTC4053          | USB Compatible Monolithic Li-Ion Battery Charger                                    | Standalone Charger with Programmable Timer, Up to 1.25A Charge Current   |
| LTC4054          | Standalone Linear Li-Ion Battery Charger with Integrated Pass Transistor in ThinSOT | Thermal Regulation Prevents Overheating, C/10 Termination, C/10 Indicator, Up to 800mA Charge Current  |
| LTC4057          | Lithium-Ion Linear Battery Charger  | Up to 800mA Charge Current, Thermal Regulation, ThinSOT Package  |
| LTC4058          | Standalone 950mA Lithium-Ion Charger in DFN   | C/10 Charge Termination, Battery Kelvin Sensing, ±7% Charge Accuracy   |
| LTC4059/LTC4059A | 900mA Linear Lithium-Ion Battery Charger  | 2mm × 2mm DFN Package, Thermal Regulation, Charge Current Monitor Output, Version A has ACPR Function  |
| LTC4061          | Standalone Li-Ion Charger with Thermistor Interface                                 | 4.2V, ±0.35% Float Voltage, Up to 1A Charge Current, 3mm × 3mm DFN   |
| LTC4061-4.4      | Standalone Li-lon Charger with Thermistor Interface                                 | 4.4V (Max), ±0.4% Float Voltage, Up to 1A Charge Current, 3mm × 3mm DFN  |
| LTC4062          | Standalone Linear Li-Ion Battery Charger with Micropower Comparator                 | 4.2V, ±0.35% Float Voltage, Up to 1A Charge Current, 3mm × 3mm DFN   |
| LTC4063          | Li-Ion Charger with Linear Regulator  | Up to 1A Charge Current, 100mA, 125mV LDO, 3mm × 3mm DFN   |
| LTC4065/LTC4065A | Standalone Li-Ion Battery Charger   | 4.2V, ±0.6% Float Voltage, Up to 750mA Charge Current, 2mm × 2mm DFN, Version A has ACPR Function  |
| LTC4411/LTC4412  | Low Loss PowerPath™ Controller in ThinSOT   | Automatic Switching Between DC Sources, Load Sharing,<br>Replaces ORing Diodes   |
| Power Management |   |  |
| LTC3405/LTC3405A | 300mA (I <sub>OUT</sub> ), 1.5MHz, Synchronous Step-Down<br>DC/DC Converter         | 95% Efficiency, V <sub>IN</sub> : 2.7V to 6V, V <sub>OUT</sub> = 0.8V, I <sub>Q</sub> = 20 $\mu$ A, I <sub>SD</sub> < 1 $\mu$ A, ThinSOT Package   |
| LTC3406/LTC3406A | 600mA (I <sub>OUT</sub> ), 1.5MHz, Synchronous Step-Down<br>DC/DC Converter         | 95% Efficiency, V <sub>IN</sub> : 2.5V to 5.5V, V <sub>OUT</sub> = 0.6V, I <sub>Q</sub> = 20 $\mu$ A, I <sub>SD</sub> < 1 $\mu$ A, ThinSOT Package |
| LTC3411          | 1.25A (I <sub>OUT</sub> ), 4MHz, Synchronous Step-Down<br>DC/DC Converter           | 95% Efficiency, V <sub>IN</sub> : 2.5V to 5.5V, V <sub>OUT</sub> = 0.8V, I <sub>Q</sub> = 60 $\mu$ A, I <sub>SD</sub> < 1 $\mu$ A, MS Package      |
| LTC3440          | 600mA (I <sub>OUT</sub> ), 2MHz, Synchronous Buck-Boost<br>DC/DC Converter          | 95% Efficiency, V <sub>IN</sub> : 2.5V to 5.5V, V <sub>OUT</sub> = 2.5V, I <sub>Q</sub> = 25 $\mu$ A, I <sub>SD</sub> < 1 $\mu$ A, MS Package      |
| LTC4413          | Dual Ideal Diode in DFN   | 2-Channel Ideal Diode ORing, Low Forward ON Resistance, Low Regulated Forward Voltage, 2.5V $\leq$ V $_{IN}$ $\leq$ 5.5V                           |
|                  |   |  |

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